



Update Notification

Document # : FPCN20930Z1

Issue Date: 23 December 2016

Title of Change:	Update Notice to FPCN20930Z - affected device list modification		
Proposed first ship date:	13 November 2017		
Contact information:	Contact your local ON Semiconductor Sales Office or <SitiNurhaza.MohdRamli@onsemi.com>		
Samples:	Contact your local ON Semiconductor Sales Office		
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <cheanching.sim@onsemi.com>		
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.		
Change category:	☒ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☐ Other _____		
Change Sub-Category(s): ☐ Manufacturing Site Change/Addition ☐ Manufacturing Process Change ☒ Material Change ☐ Product specific change ☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking ☐ Other: _____			
Sites Affected: ☒ All site(s) ☐ not applicable ☐ ON Semiconductor site(s) : ☐ External Foundry/Subcon site(s)			
Description and Purpose: FPCN20930Z was previously released to qualify Power Schottky back metal change. This Update Notification announces to customers that the following Orderable Part Number (OPN's) will be removed from FPCN20930Z: NRVB120LSFT1G NRVB120VLSFT1G NRVB130LSFT1G NRVB230LSFT1G The remaining OPNs listed below in the List of Affected Standard Parts will be retained in this FPCN20930Z and subject to the announced back metal change.			
List of affected Standard Parts: NRVBM110LT1G NRVBM110LT3G NRVBM120LT1G NRVBM120LT3G NRVBM130LT1G NRVBM130LT3G			